

December 1994

## 54F/74F08

## **Quad 2-Input AND Gate**

## **General Description**

### **Features**

This device contains four independent gates, each of which performs the logic AND function.

■ Guaranteed 4000V minimum ESD protection

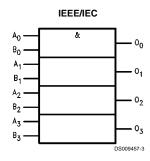
### Ordering Code: See Section 0

Commercial	Military	Package	Package Description			
		Number				
74F08PC N14A		14-Lead (0.300" Wide) Molded Dual-In-Line				
	54F08DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line			
74F08SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC			
74F08SJ (Note 1)		M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ			
	54F08FM (Note 2)	W14B	14-Lead Cerpack			
	54F08LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C			

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

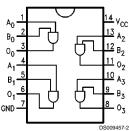
Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

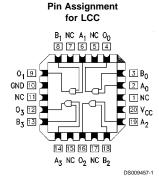
### **Logic Symbol**



### **Connection Diagrams**

Pin Assignment for DIP, SOIC and Flatpak





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# Unit Loading/Fan Out See Section 0 for U.L. definitions

		54F/74F				
Pin Names	Description	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>			
		HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>			
A <sub>n</sub> , B <sub>n</sub>	Inputs	1.0/1.0	20 μA/-0.6 mA			
On	Outputs	50/33.3	-1 mA/20 mA			

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### **Absolute Maximum Ratings** (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature -65°C to +150°C

Ambient Temperature under Bias -55°C to +125°C

Junction Temperature under Bias -55°C to +175°C

Plastic -55°C to +150°C

 $V_{\rm CC}$  Pin Potential to

Ground Pin -0.5V to +7.0V Input Voltage (Note 4) -0.5V to +7.0V Input Current (Note 4) -30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{lll} \mbox{Standard Output} & -0.5 \mbox{V to V}_{\rm CC} \\ \mbox{TRI-STATE} \mbox{Output} & -0.5 \mbox{V to +5.5 \mbox{V}} \end{array}$ 

Current Applied to Output

in LOW State (Max)  ${\rm twice \ the \ rated \ I_{OL} \ (mA)}$  ESD Last Passing Voltage (Min)  ${\rm 4000V}$ 

## Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage

Military +4.5V to +5.5V Commercial +4.5V to +5.5V

**Note 3:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

### **DC Electrical Characteristics**

Symbol	l Parameter		54F/74F			Units	V <sub>cc</sub>	Conditions	
			Min	Тур	Max	1			
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.2	V	Min	I <sub>IN</sub> = -18 mA	
V <sub>OH</sub>	Output HIGH	54F 10% V <sub>CC</sub>	2.5					$I_{OH} = -1 \text{ mA}$	
	Voltage	74F 10% V <sub>CC</sub>	2.5			V	Min	I <sub>OH</sub> = -1 mA	
		74F 5% $V_{\rm CC}$	2.7					I <sub>OH</sub> = -1 mA	
V <sub>OL</sub>	Output LOW	54F 10% V <sub>CC</sub>			0.5	V	Min	I <sub>OL</sub> = 20 mA	
	Voltage	74F 10% V <sub>CC</sub>			0.5			I <sub>OL</sub> = 20 mA	
I <sub>IH</sub>	Input HIGH	54F			20.0	μΑ	Max	V <sub>IN</sub> = 2.7V	
	Current	74F			5.0				
I <sub>BVI</sub>	Input HIGH Current	54F			100	μA	Max	V <sub>IN</sub> = 7.0V	
	Breakdown Test	74F			7.0				
I <sub>CEX</sub>	Output HIGH	54F			250	μΑ	Max	V <sub>OUT</sub> = V <sub>CC</sub>	
	Leakage Current	74F			50				
V <sub>ID</sub>	Input Leakage	74F	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA	
	Test							All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV	
	Circuit Current							All Other Pins Grounded	
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V	
los	Output Short-Circuit Current		-60		-150	mA	Max	V <sub>OUT</sub> = 0V	
I <sub>CCH</sub>	Power Supply Current			5.5	8.3	mA	Max	V <sub>O</sub> = HIGH	
I <sub>CCL</sub>	Power Supply Current			8.6	12.9	mA	Max	V <sub>O</sub> = LOW	

### **AC Electrical Characteristics**

See Section 0 for Waveforms and Load Configurations

	Parameter	74F T <sub>A</sub> = +25°C V <sub>CC</sub> = +5.0V			54F T <sub>A</sub> , V <sub>CC</sub> = Mil C <sub>L</sub> = 50 pF		74F T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF		Units	Fig. No.
Symbol										
		C <sub>L</sub> = 50 pF								
		Min	Тур	Max	Min	Max	Min	Max		
t <sub>PLH</sub>	Propagation Delay	3.0	4.2	5.6	2.5	7.5	3.0	6.6	ns	++-++
t <sub>PHL</sub>	$A_n$ , $B_n$ to $O_n$	2.5	4.0	5.3	2.0	7.5	2.5	6.3		

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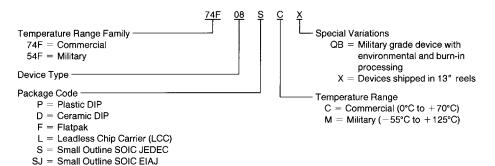
DSXXX

DSXXX

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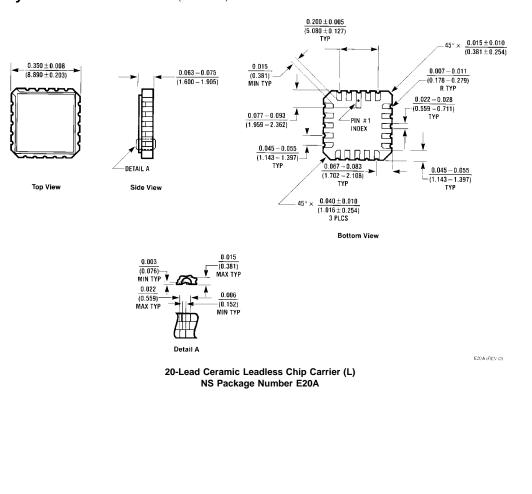
### **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

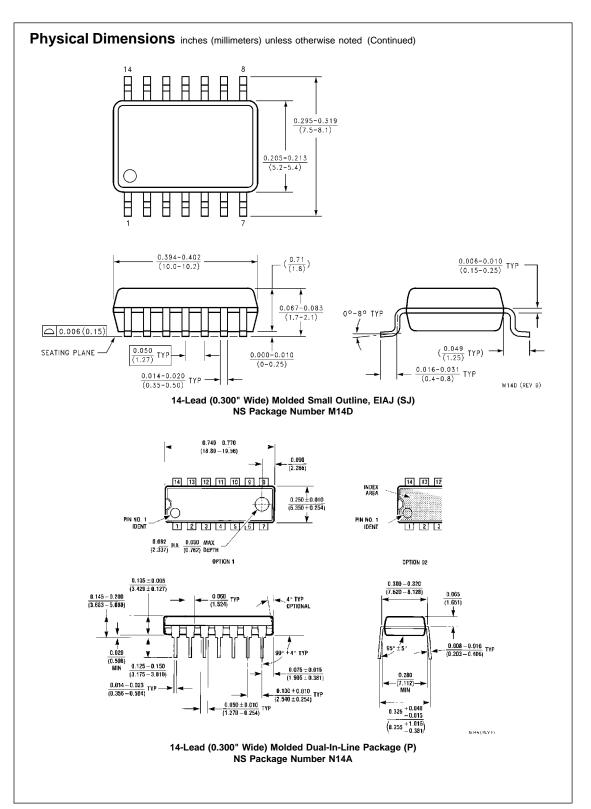


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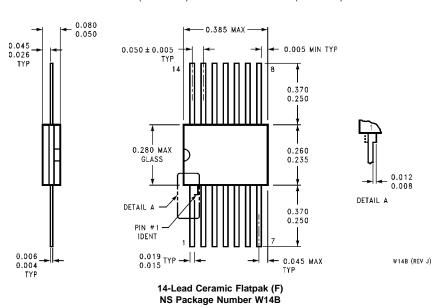
## $\begin{picture}(200,0)\put(0,0){\line(1,0){100}} \put(0,0){\line(1,0){100}} \put(0,0){\line(1,0){100$



### 0.785 (19.939) MAX 14 13 12 11 10 9 8 0,025 (0.635) RAD 0.220-0.310 (5.588-7.874) 1 2 3 4 5 6 7 0.005 (0.127) MIN 0.290-0.320 0.200 GLASS SEALANT (5.080) MAX 0.020-0.060 (7.366-8.128) 0.060 ±0.005 (1.524 ±0.127) 0.180 (4.572) MAX (0.508-1.524) 86°94° TVI 0.008-0.012 0.310-0.410 (0.203-0.305) 0.018 ±0.003 0.125--0.200 (7.874-10.41) 0.098 (0.457 ±0.076) (3.175-5.080) (2.489) MAX BOTH ENDS 0.100 ±0.010 (2.540 ±0.254) (3.81) MIN 14-Lead Ceramic Dual-In-Line Package (D) NS Package Number J14A $\frac{0.335 - 0.344}{(8.509 - 8.738)}$ LEAD NO. 1 0.010 (0.254) MAX $\frac{0.150-0.157}{(3.810-3.988)}$ $\frac{0.053 - 0.069}{(1.346 - 1.753)}$ $\frac{0.010 - 0.020}{(0.254 - 0.508)}$ 8° MAX TYP ALL LEADS $\frac{0.004 - 0.010}{(0.102 - 0.254)}$ 0.014 0.008 - 0.010 (0.203 - 0.254) TYP ALL LEADS 0.050 (1.270) TYP - 0.014 - 0.020 (0.356 - 0.508) TYP 0.016 - 0.050 (0.406 - 1.270) TYP ALL LEADS 0.004 (0.102) ALL LEAD TIPS $-\frac{0.006}{(0.203)}$ TYP MI4A (REV.H) 14-Lead (0.150" Wide) Molded Small Outline, JEDEC (S) NS Package Number M14A



### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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